

China RoHS Certificate (PDF)

MTFC64GAJEDN AIT

Part-specific certification as required by China's Management Methods for Controlling Pollution by Electronic Information Products.

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Documentation & Support

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Technical Notes

SEARCH (54) TECHNICAL NOTES

Technical Notes

TN-00-08: Thermal Applications (PDF)

DRAM
Managed NAND
Multichip Packages
NAND Flash
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(TN-00-08) Describes some considerations in thermal applications for Micron memory devices

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Technical Notes



TN-13-49: SLC NAND Device Refresh (PDF)

NAND Flash
SLC NAND

(TN-13-49) This technical note discusses the adverse effects of high temperature and PROGRAM/ERASE (P/E) cycles on flash memory data retention and how the REFRESH operation can be used to mitigate these adverse effects.

File Type: PDF Updated: 10/31/2016

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Technical Notes

TN-29-14: NAND Flash Performance Increase Using PROGRAM PAGE CACHE MODE Command (PDF)

NAND Flash

(TN-29-14) This technical note highlights the significant performance gains realized when using the PROGRAM PAGE CACHE MODE command in Micron's NAND Flash devices.

File Type: PDF Updated: 09/29/2016

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Technical Notes

TN-29-25: Improving NAND Flash Performance Using Two-Plane Command Enabled Micron Devices (PDF)

NAND Flash

(TN-29-25) This technical note describes the performance benefits of Micron two-plane commands and provides implementation guidelines for making the best use of two-plane capabilities.

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Technical Notes

TN-29-42: Wear-Leveling Techniques in NAND Flash Devices (PDF)

NAND Flash

(TN-29-42) This technical note highlights the importance of wear leveling, explains two wear-leveling techniques, and discusses implementing wear leveling.

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SEARCH (54) TECHNICAL NOTES

Customer Service Note

Customer Service Note

Customer Service Note

Shipping Quantities (PDF)

DRAM
DRAM Modules
Hybrid Memory Cube
Multichip Packages
[See More Tags](#)

(CSN-04) This customer service note describes the standard shipping quantity, box quantity, and types such as tape and reel for Micron's products.

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Updated: 07/18/2016

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Customer Service Note

Wafer Packaging and Packaging Materials (PDF)

DRAM
NAND Flash

(CSN-20) Provides complete shipping and recycling information about each of the materials used for shipping Micron's products.

File Type: PDF

Updated: 06/21/2016

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SEARCH (2) CUSTOMER SERVICE NOTE

MTFC64GAJAEDN-AIT
(Current)

[MTFC32GAKAECN-AIT](#)

[MTFC16GAKAECN-AIT](#)

[MTFC8GACAENS-AIT](#)

Where to Buy

Orderable Parts

	Status	Media	FBGA Code	SPD Data	Chipset Validation	PLP	Start Date	Alternative Part
MTFC64GAJAEDN-AIT	Production	N/A	SMPVO	N/A	N/A	No		N/A

Contact Your Sales Rep

- OR - Check with Distributors

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Your Region: Americas

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Client SSD Storage
Data Center
Embedded Memory Solutions
Enterprise SSD Storage
Mobile Memory Solutions
Networking Innovations
Supercomputing Memory
Ultrathin Solutions

Memory and Storage Products

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DRAM Modules
NAND Flash
Managed NAND
NOR Flash
Hybrid Memory Cube
Multichip Packages
Solid State Drives

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